

Quality Information for Product Type NX7002AKW

Quality and reliability data provided by Nexperia is intended to be a non-binding estimate of product performance only. It does not imply that any performance levels reflected in such data can be met if the product is operated outside the conditions expressly stated in the latest published data sheet for a device or in your application.

Quick reference

Information	Content
Device Type	NX7002AKW
Ordering Information (12NCs)	9340 662 97115
Qualification Grade	non automotive
Package	SOT323 (SC70)
Waferfab	Wafer foundry PHENITEC
Assembly	Nexperia ATSN
ESD HBM	> 250 V, <= 500 V
ESD MM	> 50 V, <= 100 V
Calculated Failure Rate	0.69 FIT
MTBF/MTTF	1.45E+09 hours

Explanation

Automotive qualified products are in accordance with the AEC-Q101.

Electrostatic Discharge (ESD) tests are performed as described in the AEC-Q101 with each 3 positive and 3 negative pulses for each stress voltage level.

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, AEC-Q101 Test # 5). The parameters for calculation of FIT and MTBF/MTTF are as follows: Confidence level 60%, junction temperature derated to 55 °C, activation energy 0.7 eV, test time 168 - 1000 hrs.

For discrete semiconductor devices the Mean Time Between Failure (MTBF) is replaced by the Mean Time To Failure (MTTF) acronym. MTTF is calculated from the Intrinsic Failure Rate.